

www.opledtw.com

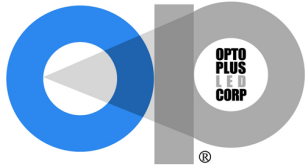
Opto Plus LED Corp
OPS-L08A16LB
Top Mount Chip LED

● **EDIT HISTORY**

Version A : Aug. 08, 2022

Preliminary Spec.

Confidential Document



www.opledtw.com

Opto Plus LED Corp

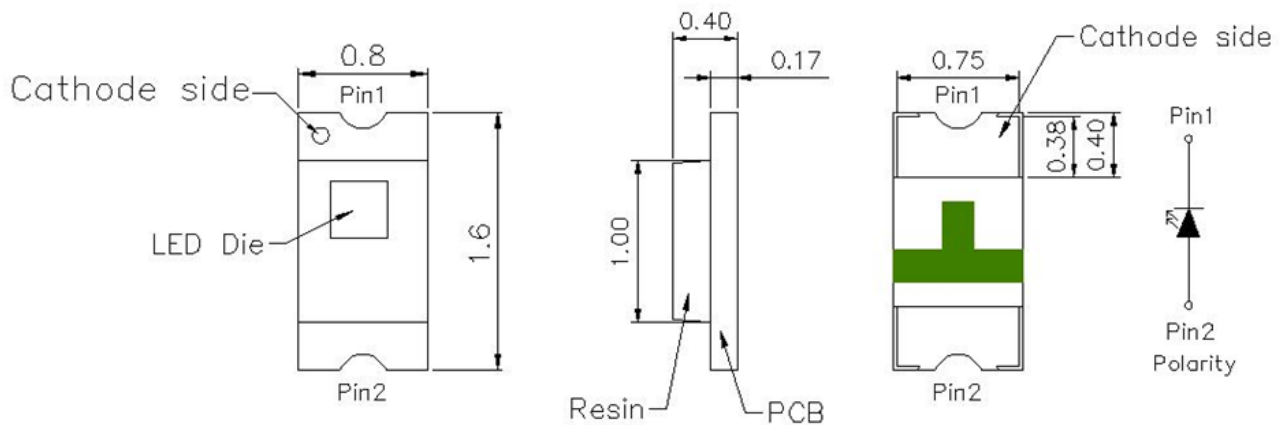
OPS-L08A16LB

Top Mount Chip LED

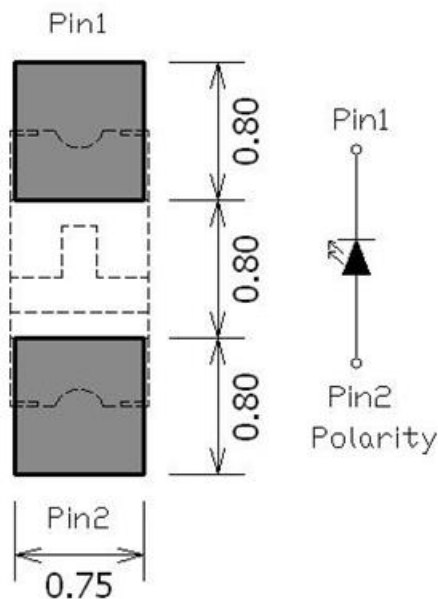
● FEATURES

- 0.8 x 1.6 x 0.4 Top Mount Chip LED
- Wide viewing angle.
- Low power consumption.
- RoHS compliant.

● PACKAGE DIMENSIONS



● SOLDERING PATTERN



Unit:mm Tolerance: +/-0.1

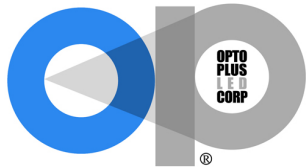
● **LB: SUPER BRIGHT BLUE (InGaN/GaN)**

ABSOLUTE MAXIMUM RATING AT Ta=25°C

Parameter	Symbol	Maximum Rating	Unit
Power dissipation per SMD	P _{AD}	70	mW
Continuous forward current per SMD	I _{AF}	20	mA
Peak current per dice (duty cycle 1/10, 1kHz)	I _{PF}	80	mA
Reverse voltage per SMD	V _R	5	V
Operating temperature	T _{OPR}	-40 to +85	°C
Storage temperature	T _{STG}	-40 to +100	°C

ELECTRICAL - OPTICAL CHARACTERISTICS AT Ta=25°C

Characteristic	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward voltage	V _F	I _F = 20mA	-	2.9	3.5	V
Reverse current	I _R	V _R = 5V	-	-	10	μA
Peak wavelength	λ _P	I _F = 20mA	-	468	-	nm
Dominant wavelength	λ _D	I _F = 20mA	-	470	-	nm
Luminous intensity	I _v	I _F = 20mA	-	285	-	mcd
Spectral radiation bandwidth	Δλ	I _F = 20mA	-	40	-	nm
Viewing Angle	2θ1/2	X	-	125	-	deg
		Y	-	135	-	



www.opledtw.com

Opto Plus LED Corp

OPS-L08A16LB

Top Mount Chip LED

● Luminous Intensity (IV) BIN: (mcd)

Bin Code	S	T
Spec. Range	180.0~285.0	285.0~360.0

Note: It maintains a tolerance of $\pm 10\%$ on Luminous Intensity

● Dominant Wavelength(Wd) Bin: (nm)

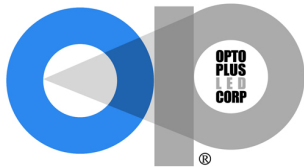
Bin Code	B	C	D
Spec. Range	464.0~468.0	468.0~472.0	472.0~476.0

Note: It maintains a tolerance of $\pm 0.5\text{nm}$ on Wavelength Bin

● Forward Voltage (Vf) Bin : (v)

Bin Code	F8	G7	G8	H7	H8	J7
Spec. Range	2.3~2.5 V	2.5~2.7 V	2.7~2.9 V	2.9~3.1 V	3.1~3.3 V	3.3~3.5 V

Note: It maintains a tolerance of $\pm 0.05\text{V}$ on forward voltage measurements



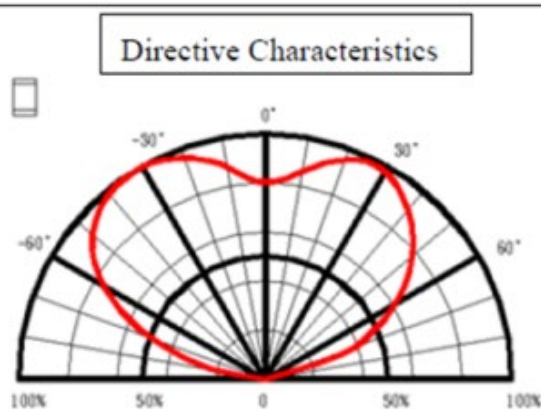
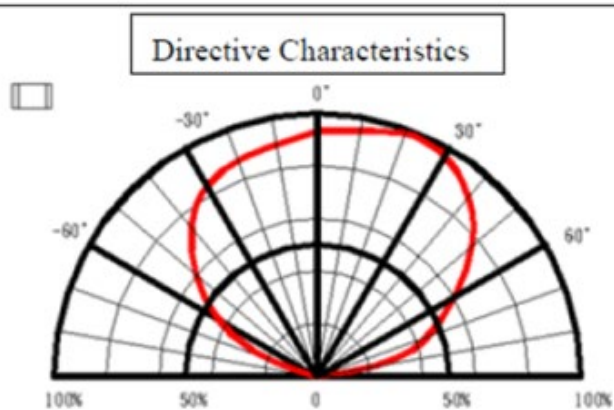
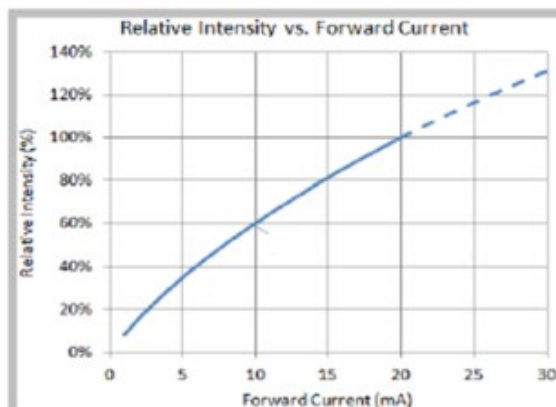
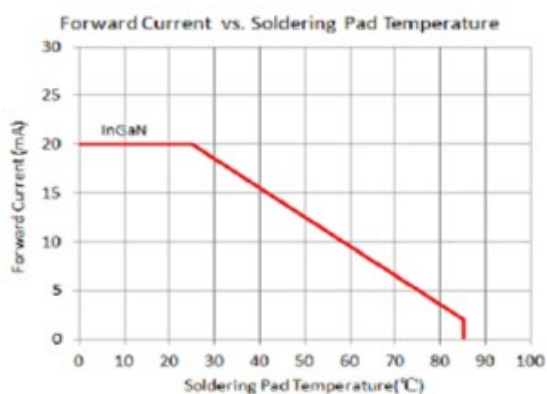
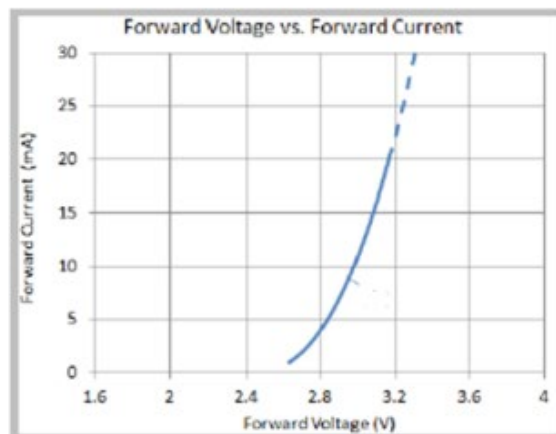
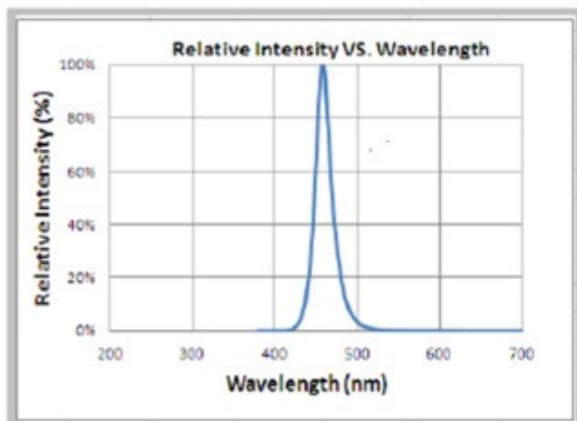
www.opledtw.com

Opto Plus LED Corp

OPS-L08A16LB

Top Mount Chip LED

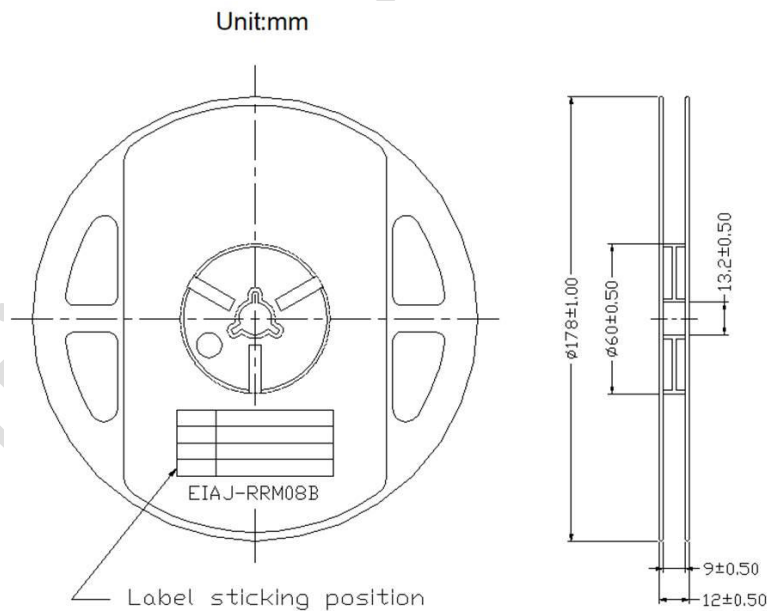
Typical Electro-optical Characteristic Curves
(25 °C Free Air Temperature Unless Otherwise Specified)

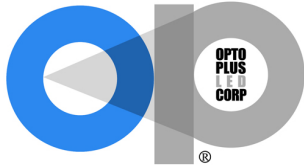


Precaution for Use

1. The chips should not be used directly in any type of fluid such as water, oil, organic solvent, etc.
2. When the LEDs are illuminating, the maximum ambient temperature should be first considered before operation.
3. LEDs must be stored in a clean environment. A sealed container with a nitrogen atmosphere is necessary if the storage period is over 3 months after shipping.
4. The LEDs must be used within 72 hrs after unpacked. Unused products must be repacked in an anti-electrostatic package, folded to close any opening and then stored in a dry and cool space.
5. The appearance and specifications of the products may be modified for improvement without further notice.
6. The LEDs are sensitive to the static electricity and surge. It is strongly recommended to use a grounded wrist band and anti-electrostatic glove when handling the LEDs. If a voltage over the absolute maximum rating is applied to LEDs, it will damage LEDs. Damaged LEDs will show some abnormal characteristics such as remarkable increase of leak current, lower turn-on voltage and getting unlit at low current.

Reel Dimension





www.opledtw.com

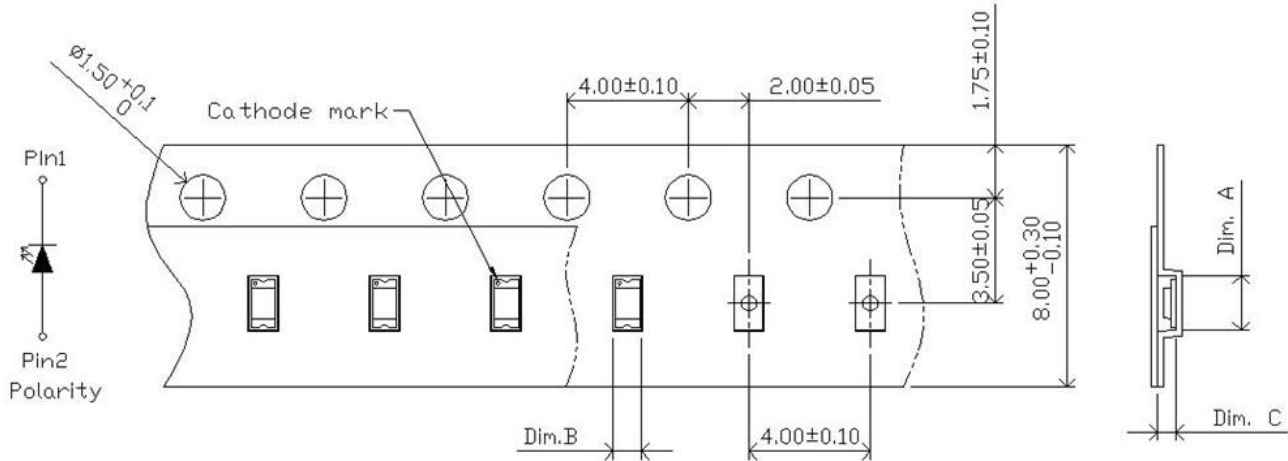
Opto Plus LED Corp

OPS-L08A16LB

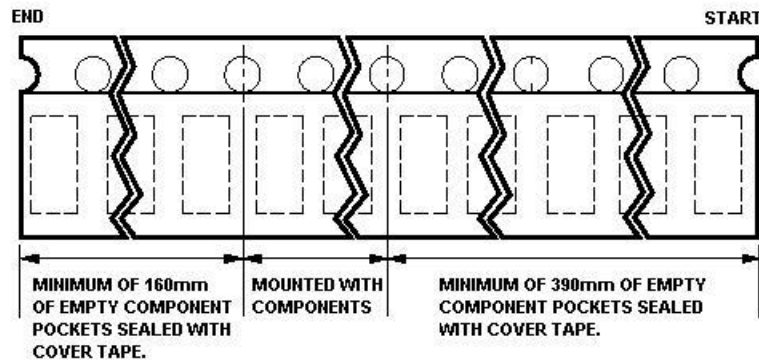
Top Mount Chip LED

Packaging

Tape Dimension



Dim. A	Dim. B	Dim. C	Q'ty/Reel
1.80 ± 0.05	0.94 ± 0.05	0.60 ± 0.05	4K

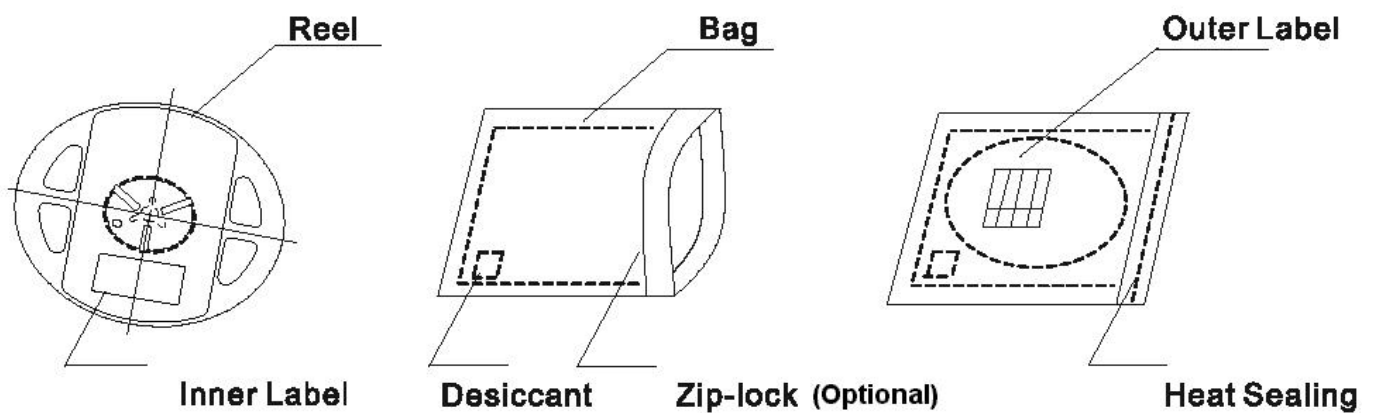


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moistureprotected anti-static bag prior to shipment.

The packaging sequence is as follows:



Baking

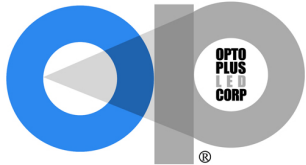
Baking before soldering is recommended when the package has been unsealed for 4 weeks.

The conditions are as followings:

1. $60 \pm 3^{\circ}\text{C} \times (12 \sim 24\text{hrs})$ and $< 5\% \text{RH}$, taped reel type.
2. $100 \pm 3^{\circ}\text{C} \times (45\text{min} \sim 1\text{hr})$, bulk type.
3. $130 \pm 3^{\circ}\text{C} \times (15\text{min} \sim 30\text{min})$, bulk type.

Precautions

1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaP products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.



www.opledtw.com

Opto Plus LED Corp

OPS-L08A16LB

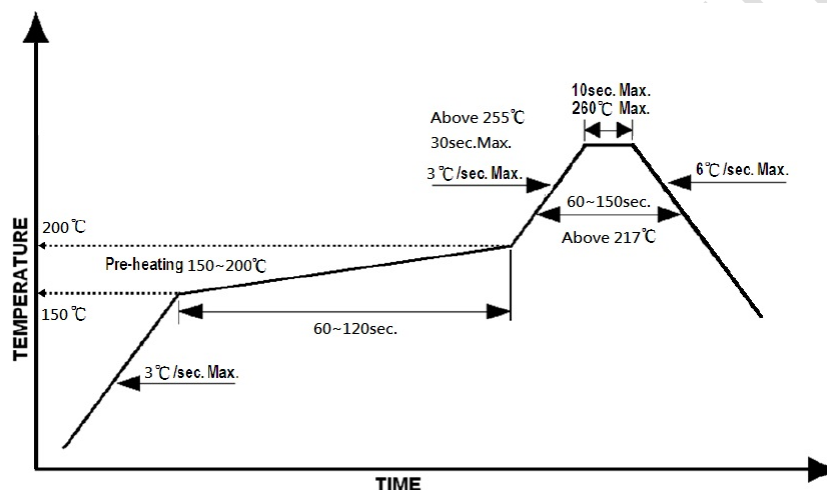
Top Mount Chip LED

Reflow Soldering

Recommend soldering paste specifications:

1. Operating temp.: Above 217°C ,60~150 sec.
2. Peak temp.:260°C Max.,10sec Max.
3. Reflow soldering should not be done more than two times.
4. Never attempt next process until the component is cooled down to room temperature after reflow.
5. The recommended reflow soldering profile (measured on the surface of the LED terminal) is as following:

Lead-free Solder Profile



Reworking

- Rework should be completed within 5 seconds under 260°C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultrasonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100°C max, <3min